

RGTH60TK65D

650V 30A Field Stop Trench IGBT

V _{CES}	650V
I _{C(100°C)}	17A
V _{CE(sat) (Typ.)}	1.6V@I _C =30A
P_D	61W

Features

- 1) Low Collector Emitter Saturation Voltage
- 2) High Speed Switching
- 3) Low Switching Loss & Soft Switching
- 4) Built in Very Fast & Soft Recovery FRD (RFN - Series)
- 5) Pb free Lead Plating; RoHS Compliant

Applications

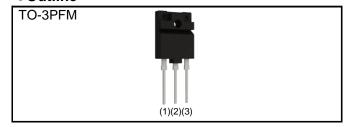
PFC

UPS

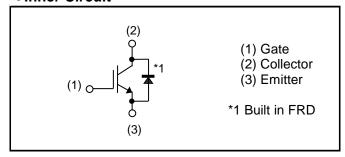
Power Conditioner

ΙH

Outline



●Inner Circuit



Packaging Specifications

	Packaging	Tube
	Reel Size (mm)	-
Tuno	Tape Width (mm)	-
Type	Basic Ordering Unit (pcs)	450
	Packing Code	C11
	Marking	RGTH60TK65D

● Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit	
Collector - Emitter Voltage		V _{CES}	650	V	
Gate - Emitter Voltage		V_{GES}	±30	V	
	T _C = 25°C	I _C	28	А	
Collector Current	T _C = 100°C	I _C	17	А	
Pulsed Collector Current	I _{CP} *1 120		А		
Die de Fermand Oromani	T _C = 25°C	I _F	28	А	
Diode Forward Current	T _C = 100°C	I _F	16	А	
Diode Pulsed Forward Current		I _{FP} *1	120	А	
Power Dissipation	T _C = 25°C	P _D	61	W	
	T _C = 100°C	P _D	30	W	
Operating Junction Temperature		T _j	-40 to +175	°C	
Storage Temperature		T _{stg}	-55 to +175	°C	

^{*1} Pulse width limited by T_{jmax.}

●Thermal Resistance

Parameter	Symbol	Values			Unit
raiametei		Min.	Тур.	Max.	Offic
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	2.43	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	-	3.76	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
raiailletei			Min.	Тур.	Max.	Offic
Collector - Emitter Breakdown Voltage	BV _{CES}	$I_C = 10 \mu A, V_{GE} = 0 V$	650	-	-	V
Collector Cut - off Current	I _{CES}	$V_{CE} = 650V, V_{GE} = 0V$	ı	1	10	μΑ
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, \ V_{CE} = 0V$	-	-	±200	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 5V, I_{C} = 21.0 \text{mA}$	4.5	5.5	6.5	V
Collector - Emitter Saturation Voltage	V _{CE(sat)}	$I_C = 30A$, $V_{GE} = 15V$ $T_j = 25$ °C $T_j = 175$ °C	-	1.6 2.1	2.1	V

ullet IGBT Electrical Characteristics (at $T_j = 25$ °C unless otherwise specified)

Parameter	Symbol	Conditions		Unit		
- arameter			Min.	Тур.	Max.	Offic
Input Capacitance	C _{ies}	V _{CE} = 30V	-	1670	-	
Output Capacitance	C _{oes}	$V_{GE} = 0V$	-	66	-	pF
Reverse Transfer Capacitance	C _{res}	f = 1MHz	-	27	-	
Total Gate Charge	Q_g	V _{CE} = 300V	-	58	-	
Gate - Emitter Charge	Q_ge	I _C = 30A	-	15	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	20	-	
Turn - on Delay Time	t _{d(on)}	$I_C = 30A, V_{CC} = 400V$	-	27	-	
Rise Time	t _r	$V_{GE} = 15V, R_G = 10\Omega$	-	40	-	20
Turn - off Delay Time	$t_{d(off)}$	T _j = 25°C	-	105	-	ns
Fall Time	t _f	Inductive Load	-	47	-	
Turn - on Delay Time	t _{d(on)}	$I_C = 30A, V_{CC} = 400V$	-	27	-	
Rise Time	t _r	$V_{GE} = 15V, R_G = 10\Omega$	-	40	-	20
Turn - off Delay Time	$t_{d(off)}$	T _j = 175°C	-	120	-	ns
Fall Time	t _f	Inductive Load	-	59	-	
		I _C = 120A, V _{CC} = 520V				
Reverse Bias Safe Operating Area	RBSOA	$V_P = 650 V, V_{GE} = 15 V$	FU	LL SQUA	RE	-
		$R_G = 60\Omega, T_j = 175^{\circ}C$				

•FRD Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Dovometer	Symbol	Conditions	Values			Linit
Parameter			Min.	Тур.	Max.	Unit
Diodo Forward Voltago	V_{F}	I _F = 20A		1.35	1.8	V
Diode Forward Voltage	۷F	$T_j = 25^{\circ}C$ $T_j = 175^{\circ}C$	-	1.15	-	V
Diode Reverse Recovery Time	t _{rr}	$I_F = 20A$ $V_{CC} = 400V$ $di_F/dt = 200A/\mu s$ $T_j = 25^{\circ}C$	-	58	-	ns
Diode Peak Reverse Recovery Current	l _{rr}		-	6.5	-	А
Diode Reverse Recovery Charge	Q _{rr}		-	0.21	-	μC
Diode Reverse Recovery Time	t _{rr}	I _F = 20A	-	236	-	ns
Diode Peak Reverse Recovery Current	I _{rr}	$V_{CC} = 400V$ $di_F/dt = 200A/\mu s$ $T_j = 175^{\circ}C$	-	10.7	-	А
Diode Reverse Recovery Charge	Q_{rr}		-	1.36	-	μC

• Electrical Characteristic Curves

Fig.1 Power Dissipation vs. Case Temperature

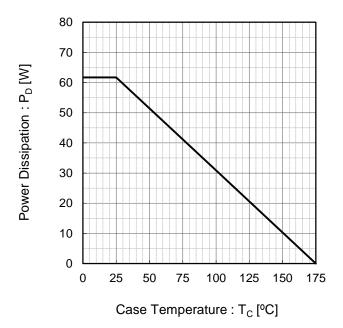


Fig.2 Collector Current vs. Case Temperature

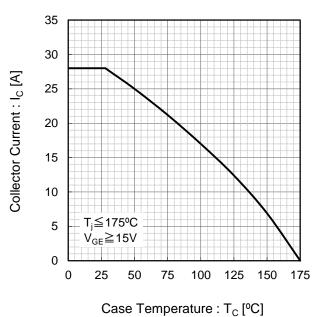


Fig.3 Forward Bias Safe Operating Area

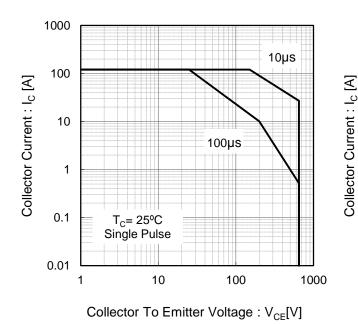
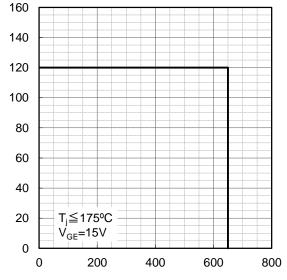


Fig.4 Reverse Bias Safe Operating Area



•Electrical Characteristic Curves

Fig.5 Typical Output Characteristics

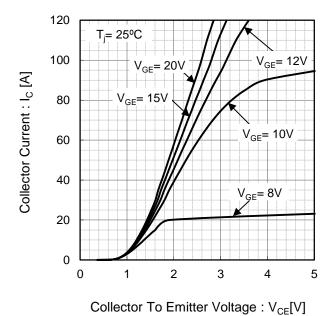
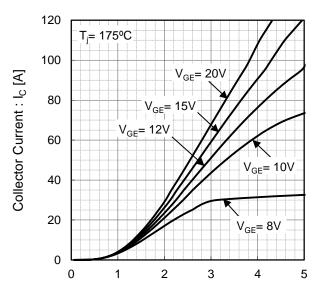


Fig.6 Typical Output Characteristics



Collector To Emitter Voltage : V_{CE}[V]

Fig.7 Typical Transfer Characteristics

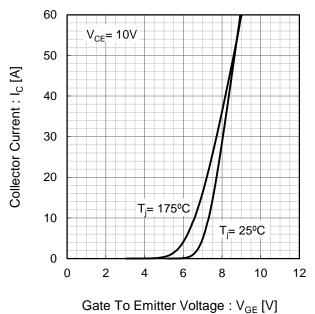
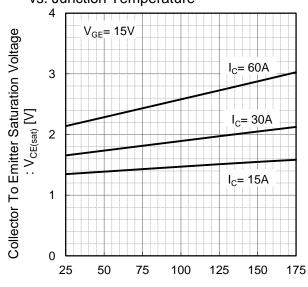
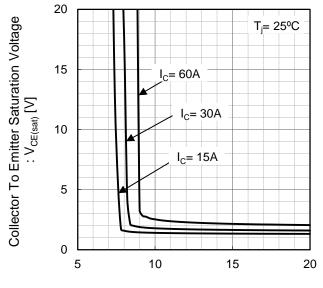


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature



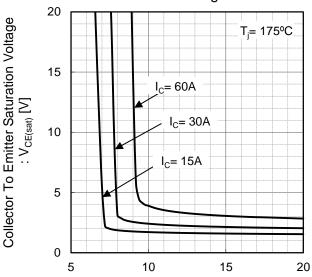
•Electrical Characteristic Curves

Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate To Emitter Voltage : V_{GE} [V]

Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate To Emitter Voltage : V_{GE} [V]

Fig.11 Typical Switching Time vs. Collector Current

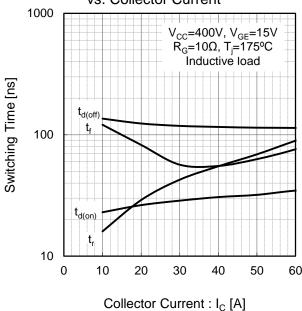
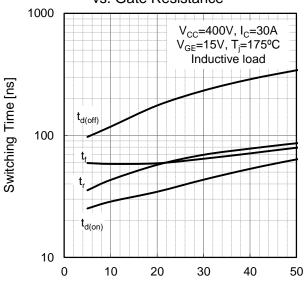


Fig.12 Typical Switching Time vs. Gate Resistance



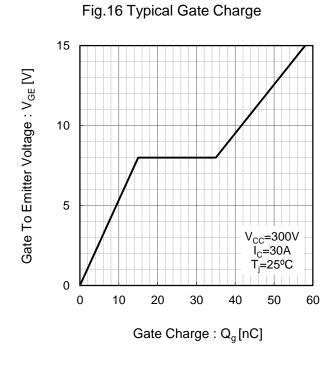
• Electrical Characteristic Curves

Fig.13 Typical Switching Energy Losses vs. Collector Current 10 Switching Energy Losses [mJ] 1 0.1 V_{CC} =400V, V_{GE} =15V R_{G} =10 Ω , T_{j} =175°C Inductive load 0.01 0 10 20 30 40 50 60 Collector Current : I_C [A]

Fig.14 Typical Switching Energy Losses vs. Gate Resistance

10 E_{off} $V_{cc}=400V, I_{c}=30A$ $V_{GE}=15V, T_{j}=175^{\circ}C$ Inductive load 0.01

Fig.15 Typical Capacitance vs. Collector To Emitter Voltage 10000 Cies 1000 Capacitance [pF] Coes 100 Cres 10 f=1MHz V_{GE}=0V T_i=25°C 0.01 0.1 1 10 100 Collector To Emitter Voltage : V_{CE}[V]



• Electrical Characteristic Curves

Fig.17 Typical Diode Forward Current vs. Forward Voltage 120 100 Forward Current : I_F [A] 80 60 40 T_j= 175°C 20 T_i= 25°C 0 2 3 0 0.5 1.5 2.5 Forward Voltage: V_F[V]

Fig.18 Typical Diode Reverse Recovery Time vs. Forward Current 400 V_{CC} =400V di_F/dt=200A/µs Reverse Recovery Time: t_{rr} [ns] Inductive load 300 T_j= 175°C 200 100 T_i= 25°C 0 0 10 20 30 40 50 Forward Current : I_F [A]

Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

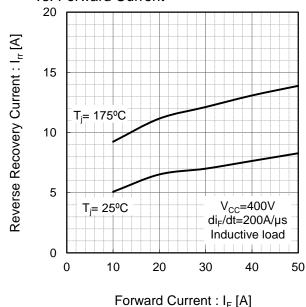
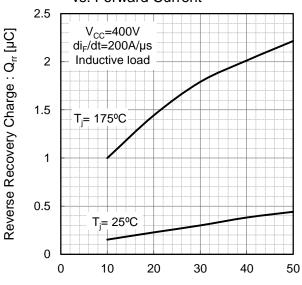


Fig.20 Typical Diode Reverse Recovery Charge vs. Forward Current



•Electrical Characteristic Curves

Fig.21 IGBT Transient Thermal Impedance

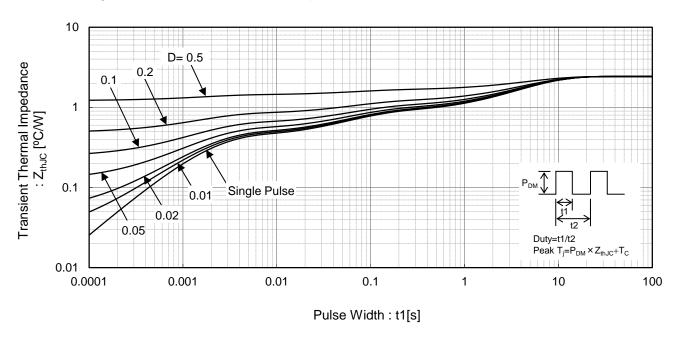
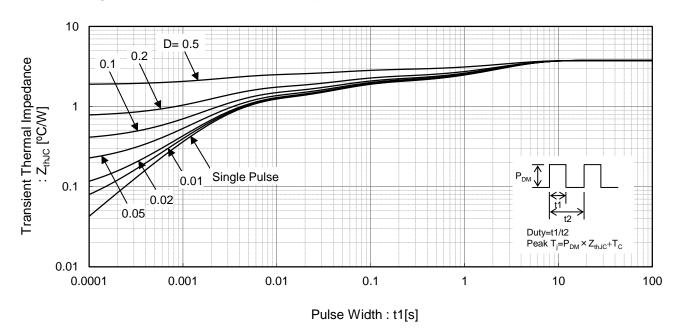


Fig.22 Diode Transient Thermal Impedance



●Inductive Load Switching Circuit and Waveform

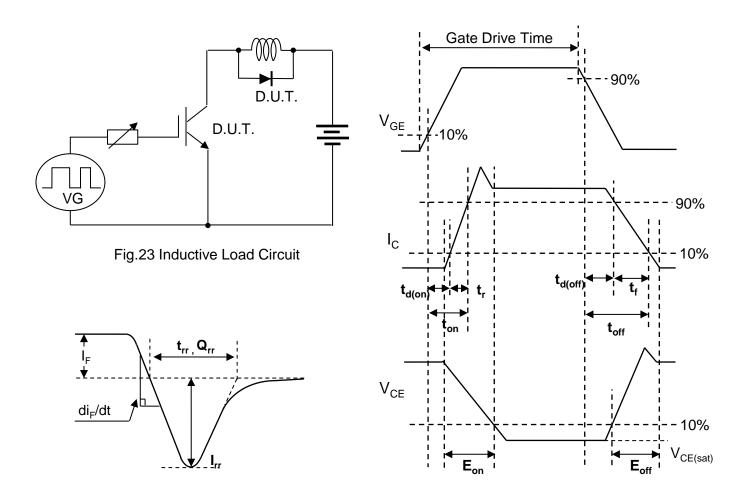


Fig.25 Diode Reverce Recovery Waveform

Fig.24 Inductive Load Waveform

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